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Doctor Horace (Carter)

TSMC-03-461

Agreement Number

10/780, 512

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Tai-Chun Huang et al.

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U. S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

OTHER DOCUMENTS (Including Author, Title, Date, Portion of Pages, Etc.)

C.C. -	Co-pending U.S. Patent App. Serial No. 09/989,837, filed on 11/20/01, assigned to the same assignee, "RF Seal Ring Structure".
C.C. -	U.S. Patent App. Pub. US 2001/0030358 A1 to Okada et al., Pub. Date 10/18/01, Filed 02/28/01, U.S.C.I. 257/678, "Semiconductor Device Package".
C.C. -	

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